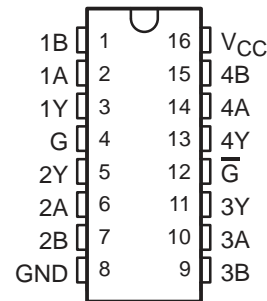


SN75ALS173 QUADRUPLE DIFFERENTIAL LINE RECEIVER

SLLS132C – SEPTEMBER 1991 – REVISED MAY 1995

- Meets or Exceeds the Requirements of ANSI EIA/TIA-422-B, EIA/TIA-423-B, and RS-485
- Meets or Exceeds the Requirements of ITU Recommendations V.10, V.11, X.26, and X.27
- Designed for Multipoint Bus Transmission on Long Bus Lines in Noisy Environments
- 3-State Outputs
- Common-Mode Input Voltage Range of -12 V to 12 V
- Input Sensitivity . . . $\pm 200\text{ mV}$
- Input Hysteresis . . . 50 mV Typ
- High Input Impedance . . . $12\text{ k}\Omega\text{ Min}$
- Operates From Single 5-V Supply
- Low Supply-Current Requirement 27 mA Max

N OR NS† PACKAGE
(TOP VIEW)



† The NS package is only available left-end taped and reeled (order device SN75ALS173 NSLE).

description

The SN75ALS173 is a monolithic quadruple differential line receiver with 3-state outputs. It is designed to meet the requirements of ANSI Standards EIA/TIA-422-B, EIA/TIA-423-B, RS-485, and several ITU recommendations. Advanced low-power Schottky technology provides high speed without the usual power penalty. The four receivers have an ORed pair of enables in common. Either G high or \bar{G} low enables all of the receivers. The device features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of $\pm 200\text{ mV}$ over a common-mode input voltage range of -12 V to 12 V .

The SN75ALS173 is characterized for operation from 0°C to 70°C .

FUNCTION TABLE
(each receiver)

DIFFERENTIAL A – B	ENABLES		OUTPUT Y
	G	\bar{G}	
$V_{ID} \geq 0.2\text{ V}$	H	X	H
	X	L	H
$-0.2\text{ V} < V_{ID} < 0.2\text{ V}$	H	X	?
	X	L	?
$V_{ID} \leq -0.2\text{ V}$	H	X	L
	X	L	L
X	L	H	Z
Open Circuit	H	X	H
	X	L	H

H = high level, L = low level, ? = indeterminate,
X = irrelevant, Z = high impedance (off)



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

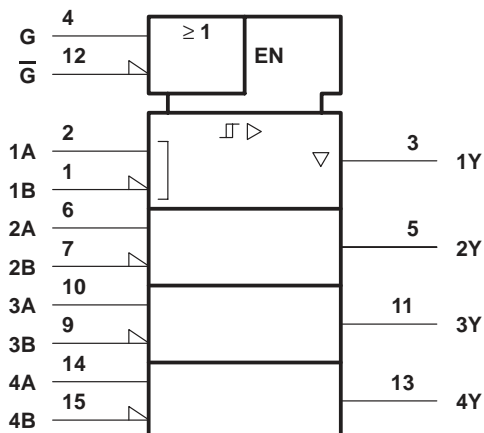
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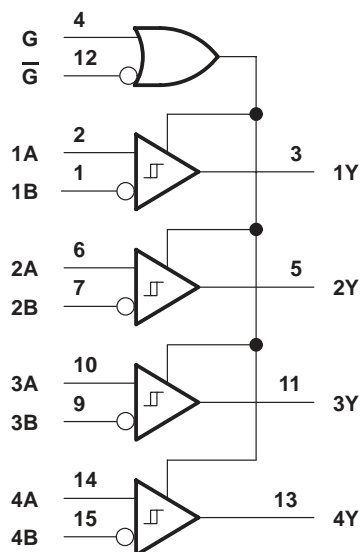
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logic symbol†

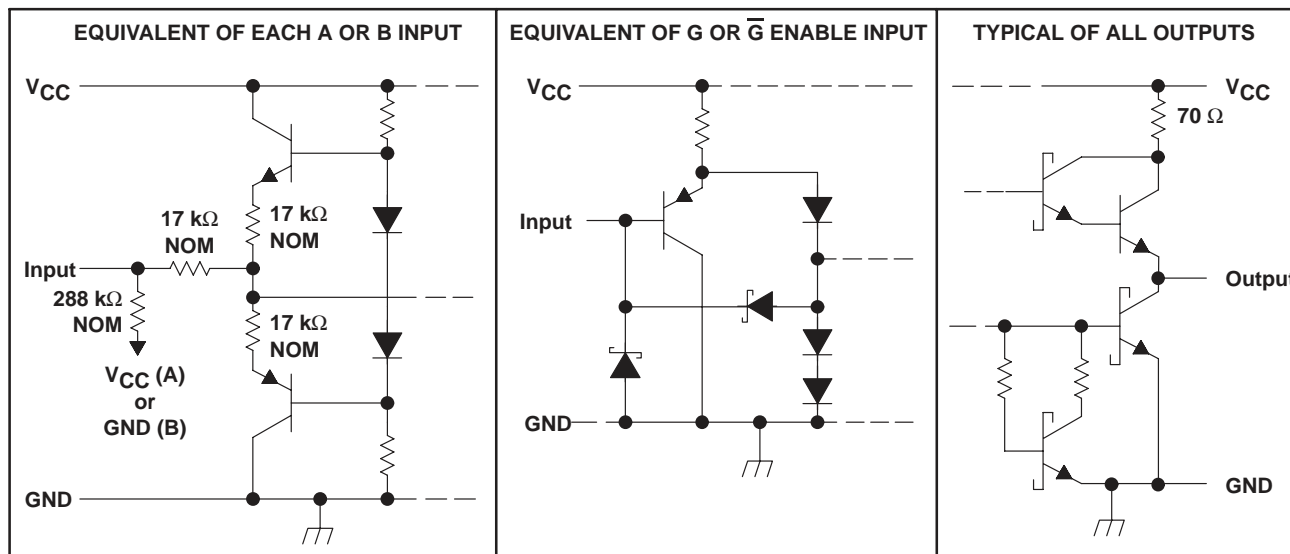


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



schematics of inputs and outputs



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage, V_I (A or B inputs)	± 14 V
Differential input voltage, V_{ID} (see Note 2)	± 14 V
Enable input voltage, V_I	7 V
Low-level output current, I_{OL}	50 mA
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range, T_{stg}	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.
 2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING
N	1150 mW	9.2 mW/ $^\circ\text{C}$	736 mW
NS	625 mW	5.0 mW/ $^\circ\text{C}$	400 mW

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}		4.75	5	5.25	V
Common-mode input voltage, V_{IC}				± 12	V
Differential input voltage, V_{ID}				± 12	V
High-level input voltage, V_{IH}	G, \bar{G}	2			V
Low-level input voltage, V_{IL}	G, \bar{G}			0.8	V
High-level output current, I_{OH}				-400	μA
Low-level output current, I_{OL}				8	mA
Operating free-air temperature, T_A		0		70	$^\circ\text{C}$

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electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted) (see Note 3)

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V_{IT+}	Positive-going input threshold voltage				200	mV
V_{IT-}	Negative-going input threshold voltage		-200‡			mV
V_{hys}	Hysteresis voltage ($V_{IT+} - V_{IT-}$)			50		mV
V_{IK}	Input clamp voltage	G, \bar{G} $I_I = -18 \text{ mA}$			-1.5	V
V_{OH}	High-level output voltage	$V_{ID} = 200 \text{ mV}$, $I_{OH} = -400 \text{ } \mu\text{A}$, See Figure 1		2.7		V
V_{OL}	Low-level output voltage	$V_{ID} = -200 \text{ mV}$, $I_{OL} = 8 \text{ mA}$, See Figure 1			0.45	V
I_{OZ}	High-impedance-state output current	$V_O = 0.4 \text{ V to } 2.4 \text{ V}$			± 20	μA
I_I	Line input current	Other input at 0 V			1	mA
		$V_I = 12 \text{ V}$ $V_I = -7 \text{ V}$			-0.8	
I_{IH}	High-level input current	G, \bar{G} $V_{IH} = 2.7 \text{ V}$			20	μA
I_{IL}	Low-level input current	G, \bar{G} $V_{IL} = 0.4 \text{ V}$			-100	μA
r_i	Input resistance			12		k Ω
I_{OS}	Short-circuit output current	See Note 4		-15	-85	mA
I_{CC}	Supply current (total package)	No load, Outputs enabled		16	24	mA
		No load, Outputs disabled		18	27	

† All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^\circ\text{C}$.

‡ The algebraic convention, in which the less positive (more negative) limit is designated as minimum, is used in this data sheet for threshold voltage levels only.

NOTES: 3. Refer to ANSI Standard RS-485 for exact conditions.

4. The duration of the short circuit should not cause the maximum package power dissipation to be exceeded.

switching characteristics, $V_{CC} = 5 \text{ V}$, $C_L = 15 \text{ pF}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PHL}	Propagation delay time, high- to low-level output	$V_{ID} = -2.5 \text{ V to } 2.5 \text{ V}$, See Figure 2	9	18	27	ns
t_{PLH}	Propagation delay time, low- to high-level output		9	18	27	ns
t_{PZH}	Output enable time to high level	See Figure 3	4	12	18	ns
t_{PZL}	Output enable time to low level	See Figure 4	6	13	21	ns
t_{PHZ}	Output disable time from high level	See Figure 3	10	21	27	ns
t_{PLZ}	Output disable time from low level	See Figure 4	8	15	25	ns

PARAMETER MEASUREMENT INFORMATION

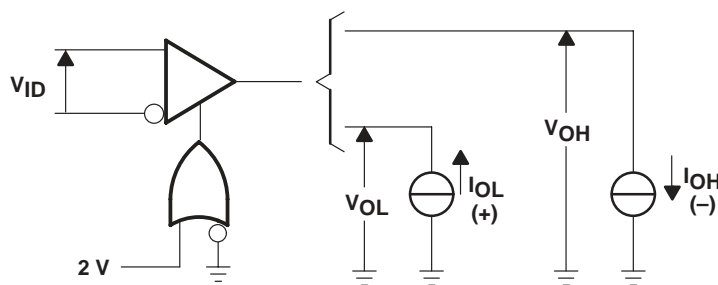


Figure 1. V_{OH} , V_{OL}

PARAMETER MEASUREMENT INFORMATION

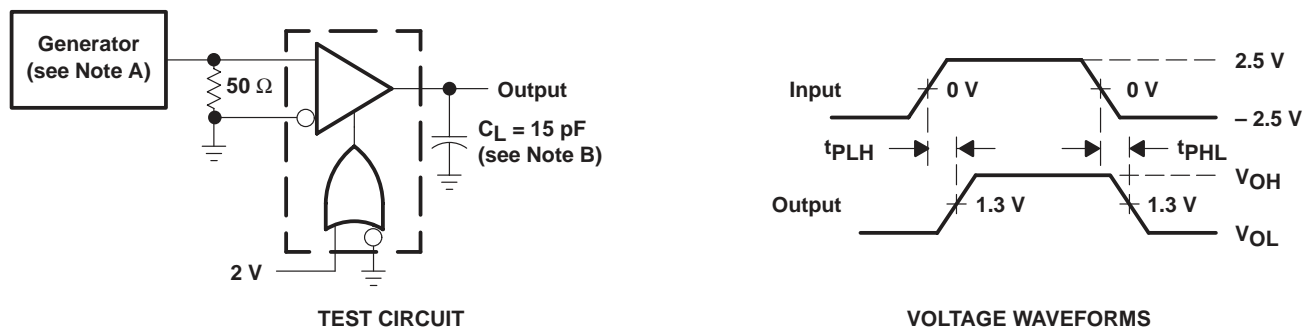


Figure 2. Test Circuit and Voltage Waveforms

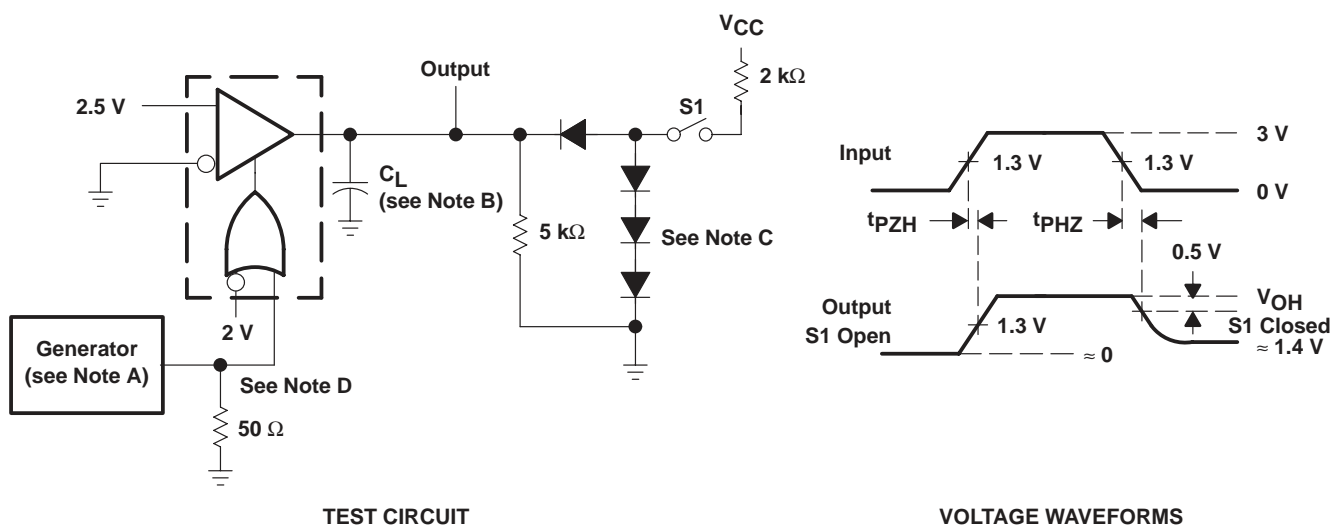


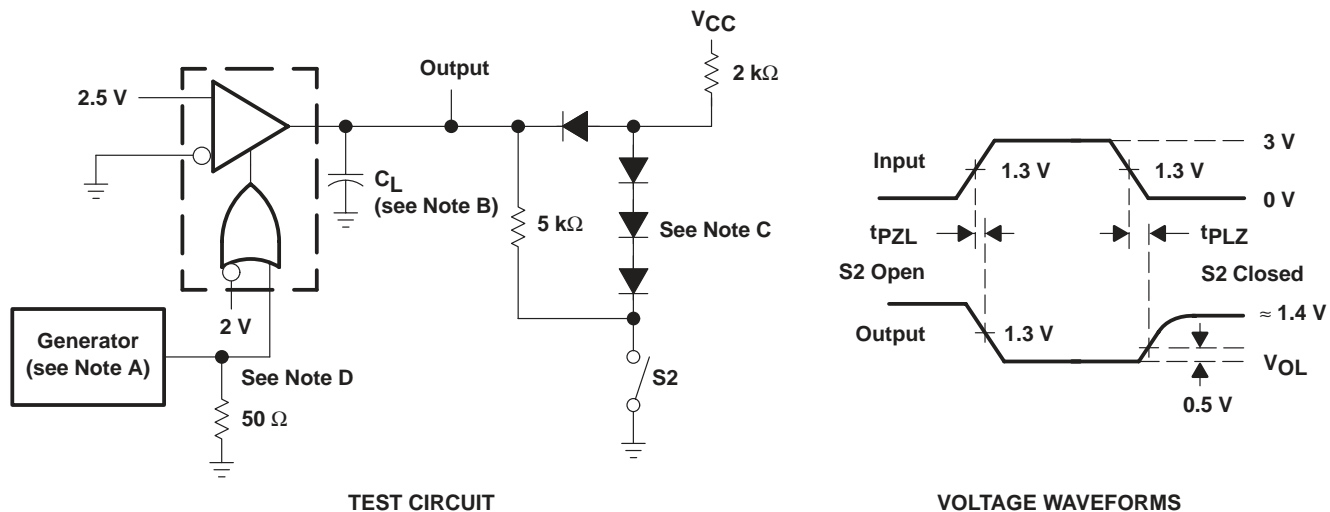
Figure 3. Test Circuit and Voltage Waveforms

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_r \leq 6$ ns, $t_f \leq 6$ ns, $Z_0 = 50 \Omega$.
 B. C_L includes probe and jig capacitance.
 C. All diodes are 1N916 or equivalent.
 D. To test the active-low enable \bar{G} , ground G and apply an inverted input waveform to \bar{G} .

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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%, $t_r \leq 6$ ns, $t_f \leq 6$ ns, $Z_O = 50 \Omega$.
- B. C_L includes probe and jig capacitance.
- C. All diodes are 1N916 or equivalent.
- D. To test the active-low enable \overline{G} , ground G and apply an inverted input waveform to \overline{G} .

Figure 4. Test Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN75ALS173N	LIFEBUY	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN75ALS173N	
SN75ALS173NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS173	Samples
SN75ALS173NSRG4	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS173	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

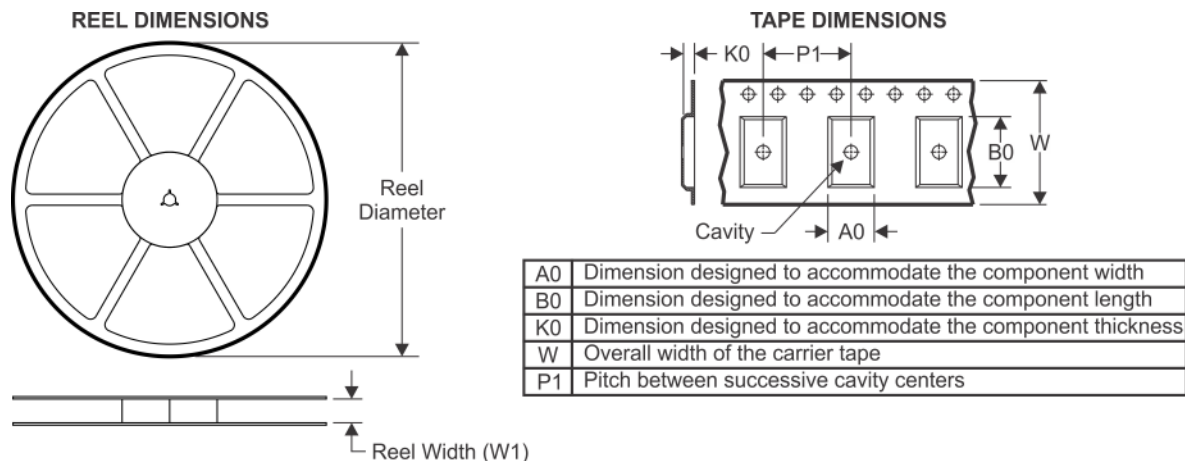
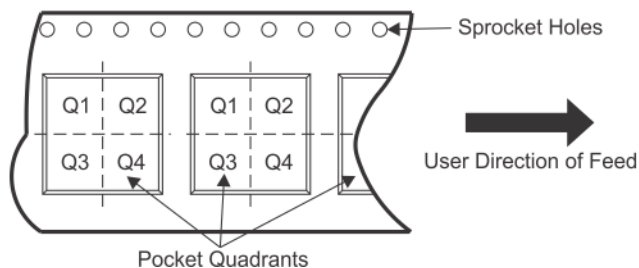
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75ALS173NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75ALS173NSR	SO	NS	16	2000	367.0	367.0	38.0

TUBE



*All dimensions are nominal

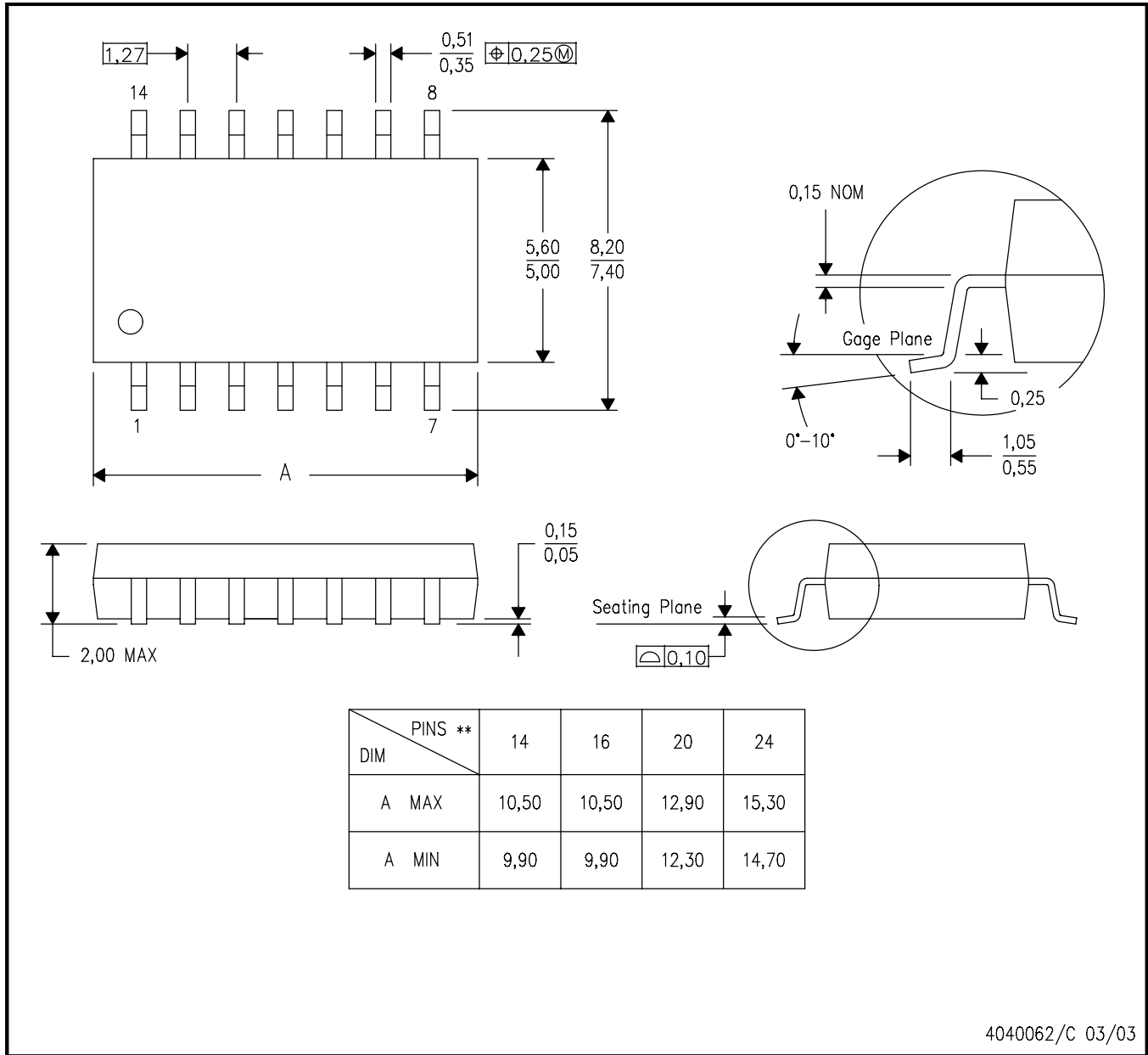
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN75ALS173N	N	PDIP	16	25	506	13.97	11230	4.32

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

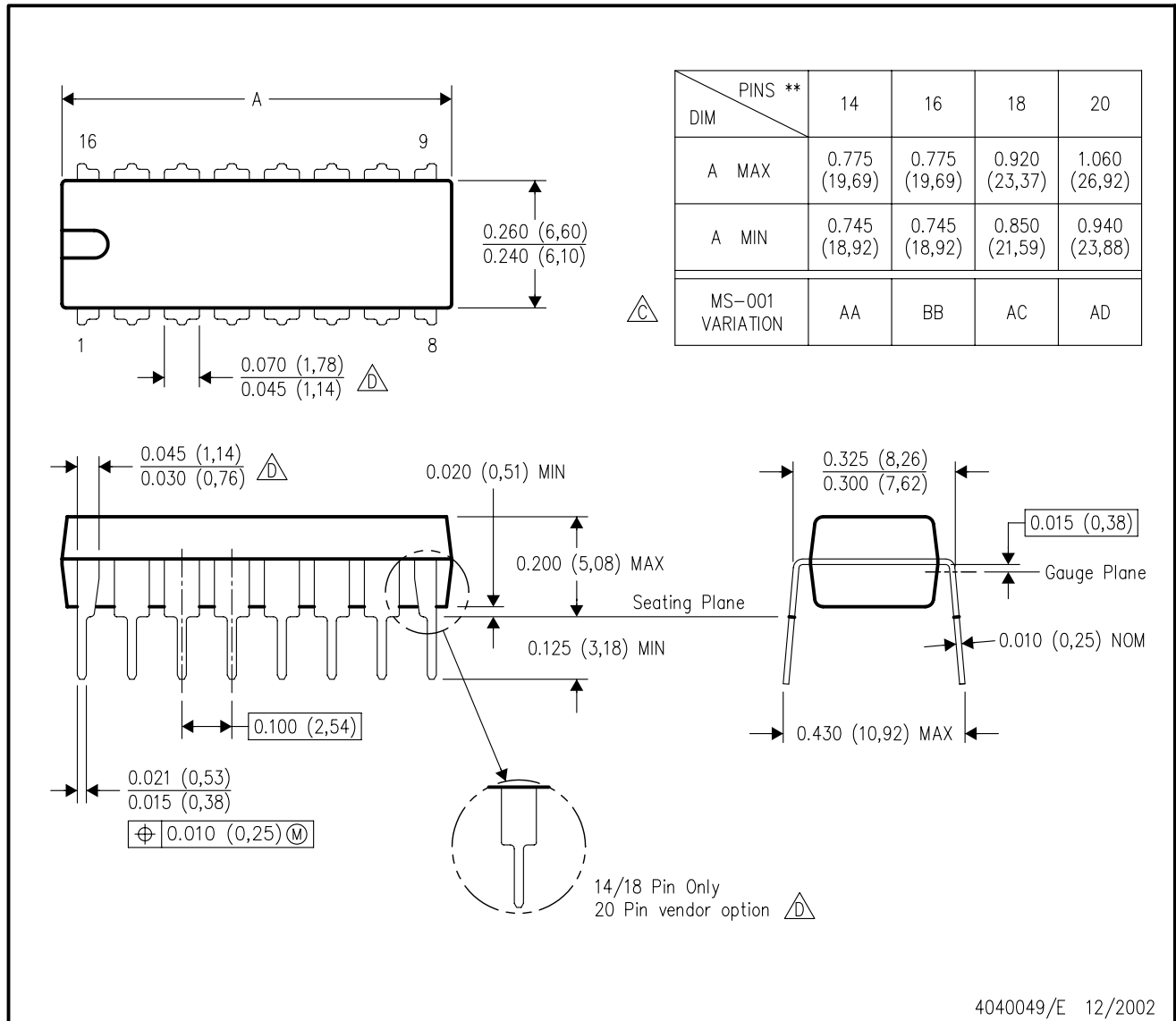


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

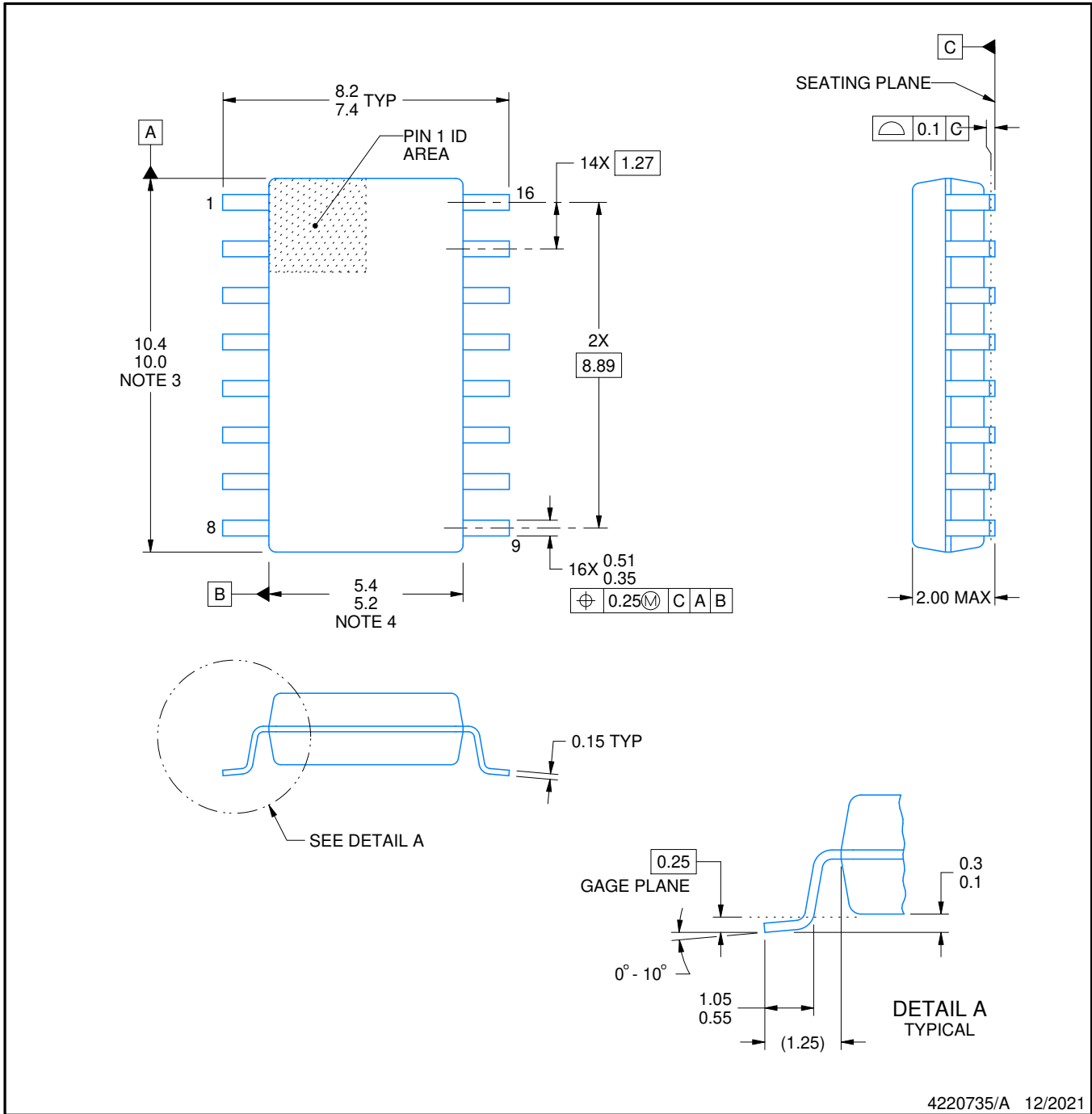


PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

SOP



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NOTES:

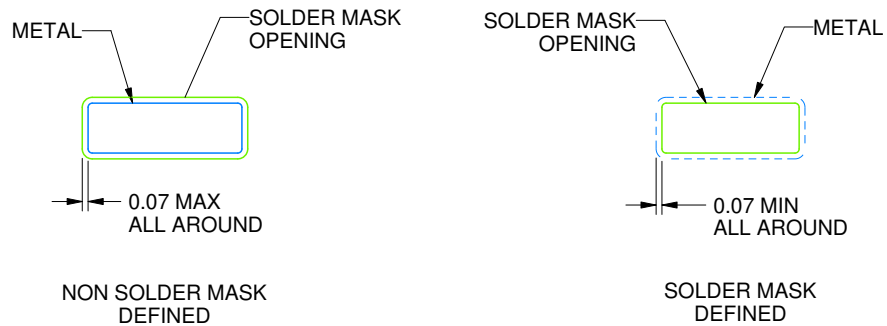
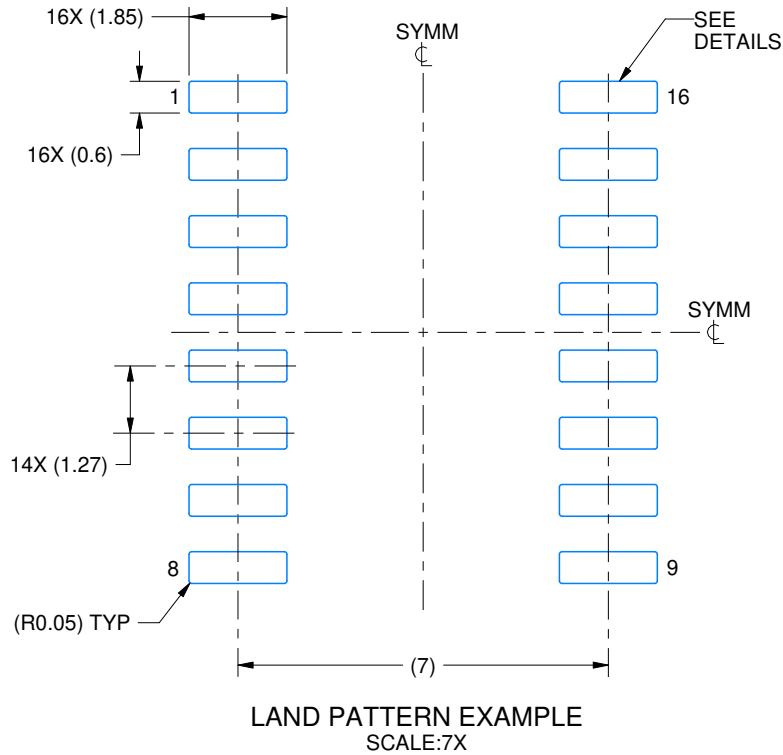
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

EXAMPLE BOARD LAYOUT

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER MASK DETAILS

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NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

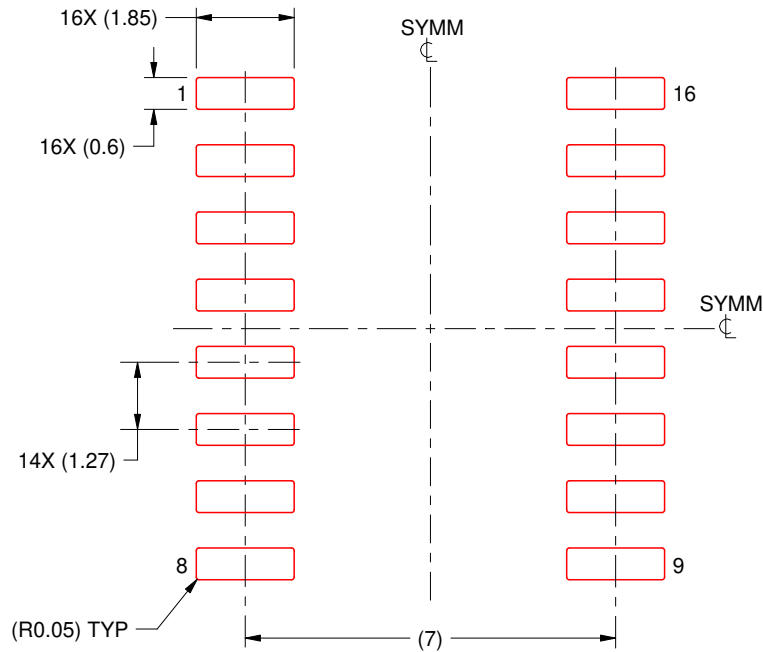
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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